



SMD Comm X8G HT150C, Ceramic, 10 pF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



| General Information      |  |  |
|--------------------------|--|--|
| Series                   | SMD Comm X8G HT150C                          |  |
| Style                    | SMD Chip                                     |  |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |  |
| Features                 | High Temperature, Ultra-Stable               |  |
| RoHS                     | Yes  |  |
| Termination              | Tin  |  |
| Marking                  | No   |  |
| AEC-Q200                 | No   |  |
| Typical Component Weight | 3.7 mg                                       |  |
| Shelf Life               | 78 Weeks                                     |  |
| MSL                      | 1  |  |

10 pF

10/

1 MHz 1.0Vrms

100 GOhms

| Dimensions |                  |
|------------|------------------|
| Chip Size  | 0603             |
| L          | 1.6mm +/-0.15mm  |
| W          | 0.8mm +/-0.15mm  |
| Т          | 0.8mm +/-0.07mm  |
| S          | 0.5mm MIN        |
| В          | 0.35mm +/-0.15mm |
|            |                  |

| Packaging Specifications |                  |
|--------------------------|------------------|
| В                        | 0.35mm +/-0.15mm |
| S                        | 0.5mm MIN        |
| Т                        | 0.8mm +/-0.07mm  |
| W                        | 0.8mm +/-0.15mm  |

| VV                       | 0.611111 +/-0.15111111 | Tolerance                                     | 170  |
|--------------------------|------------------------|---|--|
| Т                        | 0.8mm +/-0.07mm        | Voltage DC                                    | 250 VDC  |
| S                        | 0.5mm MIN              | Dielectric Withstanding Voltage               | 625 VDC  |
| В                        | 0.35mm +/-0.15mm       | Temperature Range                             | -55/+150°C   |
|                          |                        | Temp. Coefficient                             | X8G  |
| Packaging Specifications |                        | Capacitance Change with                       | 30 ppm/C, 1MegaHz 1.0Vrms                          |
| Packaging                | T&R, 330mm, Paper Tape | Reference to +25°C and 0 VDC<br>Applied (TCC) |  |
| Packaging Quantity 15000 | Dissipation Factor     | 0.1% 1 MHz 1.0Vrms                            |  |
|                          |                        | Aging Rate                                    | 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |

**Specifications** 

Measurement Condition

Insulation Resistance

Capacitance

Tolerance

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